

RF Inductor



BWLS Series



Overview

Wire-wound RF inductors are electronic components designed to store energy in a magnetic field when electrical current passes through them. They are constructed by winding a conductive wire (usually copper or gold-plated) around a core material such as air, ceramic, or ferrite.

This configuration allows them to provide high inductance values with minimal power loss, especially at high frequencies.

Benefits

1. High Q-Factor (Quality Factor)
2. Ceramic body and wire wound construction provide high SRFs
3. Low DC resistance design
4. High Current Handling
5. Low inductance value

Applications

1. Industrial and Medical Equipmen: RFID systems and medical imaging equipment.
2. Data Centers
3. Networking
4. Base Station
5. Consumer Electronics
6. Security system

Product Information

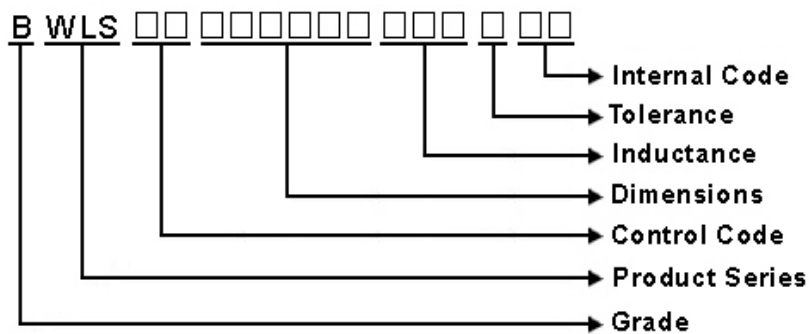
Series	Size Code (JIS/EIA)	Inductance (nH)
BWLS	0603/0201	0.0047 ~ 560
	1005/0402	
	1608/0603	
	2012/0805	
	2520/1008	



BWLS00060404 Series Specification

1 Scope: This specification applies to Wire Wound Ferrite Chip Inductors

2 Part numbering:



3 Rating:

Operating Temperature: - 40°C ~ 105°C
(Including self - temperature rise)

Storage Temperature: - 40°C ~ 105°C
(The storage temperature range is for after the assembly)

4 Marking:

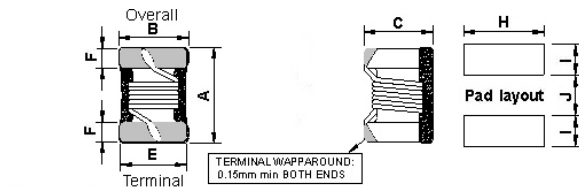
No Marking

5 Standard Testing Condition

	Unless otherwise specified	In case of doubt
Temperature	Ordinary Temperature(15 to 35°C)	20 to 30°C
Humidity	Ordinary Humidity(25 to 85% RH)	50 to 80 %RH

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6 Configuration and Dimensions and Unit Weight:



Dimensions in mm

TYPE	A	B	C	E	F	H	I	J
060404	0.58Max.	0.46Max.	0.45Max.	0.38	0.12	0.46	0.18	0.22

Net Weight (grms)

SIZE CODE	Net Weight (grms)
060404	0.00031 (typ.)

7 Electrical Characteristics:

Part No.	Inductance (nH)	L/Q Test Freq. (MHz)	Q Typ.	SRF (MHz)Min.	RDC (Ω)Max.	I _{rms} (mA)Typ.	Tolerance (±%)
BWLS000604042N□00	2.2	100	5	3000	0.09	1600	10
BWLS000604046N8□00	6.8	100	6	2400	0.11	950	5,10
BWLS000604047N8□00	7.8	100	7	2500	0.11	1050	5,10
BWLS0006040415N□00	15	100	7	2300	0.12	750	5,10
BWLS0006040417N□00	17	100	7	2400	0.13	750	5,10
BWLS0006040426N□00	26	100	7	2200	0.2	750	5,10
BWLS0006040428N□00	28	100	7	2400	0.2	700	5,10
BWLS0006040439N□00	39	100	7	2300	0.24	580	5,10
BWLS0006040443N□00	43	100	7	2200	0.24	600	5,10
BWLS0006040456N□00	56	100	7	2200	0.26	550	5,10
BWLS0006040459N□00	59	100	7	2200	0.26	500	5,10
BWLS0006040476N□00	76	100	7	2000	0.3	500	5,10
BWLS0006040478N□00	78	100	7	2000	0.3	500	5,10
BWLS00060404R10□00	100	100	7	1500	0.41	430	5,10
BWLS00060404R13□00	130	100	7	1500	0.44	400	5,10
BWLS00060404R16□00	160	100	7	1400	0.71	350	5,10
BWLS00060404R20□00	200	50	9	1400	0.95	260	5,10

NOTE: □-tolerance J=±5% / K=±10%

1. Operating temperature range —40°C ~ 105°C (Including self - temperature rise)

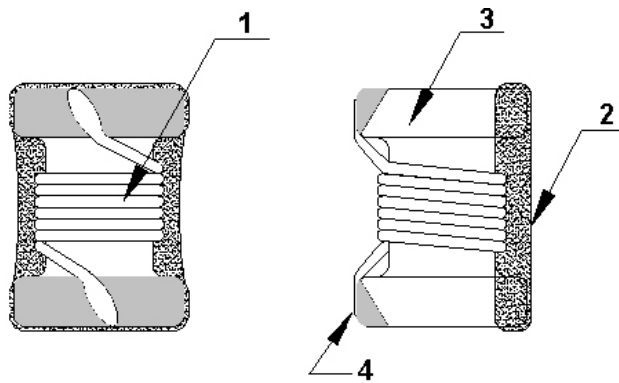
2. L/Q Test OSC @200mV.

3. I_{rms} for a 15°C temperature rise from 25°C ambient.

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8 BWLS00060404 Series

8.1 Construction:



8.2 Material List:

NO	PART	MATERIAL
1	WIRE	COPPER 180
2	EPOXY	UV GLUE
3	CORE	FERRITE
4	TERMINAL	Ag/Ni/Sn

BWLS00060404 Series Specification

9 Reliability Of Ferrite Wire Wound Chip Inductor/FERRITE SERIES

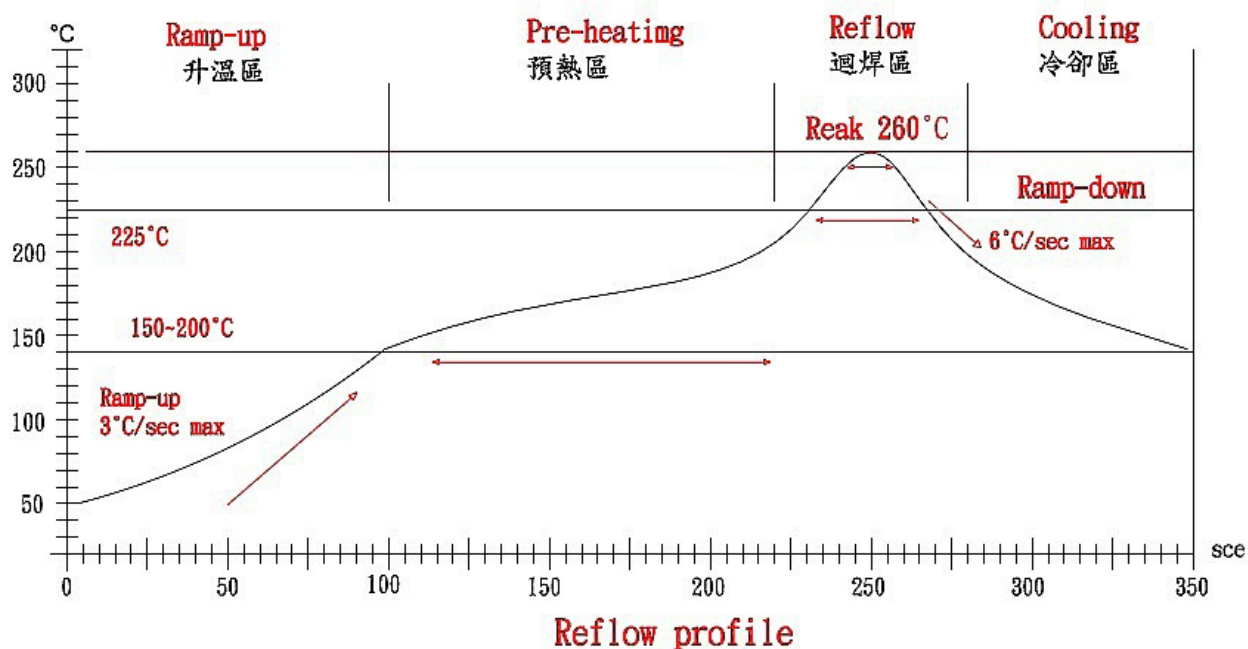
1-1.Environmental Performance

No	Item	Specification	Test Method															
1-1-1	Temperature Cycle	Appearance: No Damage Inductance:within±10% of initial value Q change:within±30% of initial value	One cycle:															
			<table><tr><th>Step</th><th>Temperature (°C)</th><th>Time (min)</th></tr><tr><td>1</td><td>-40±3</td><td>30</td></tr><tr><td>2</td><td>25±2</td><td>3</td></tr><tr><td>3</td><td>105±3</td><td>30</td></tr><tr><td>4</td><td>25±2</td><td>3</td></tr></table>	Step	Temperature (°C)	Time (min)	1	-40±3	30	2	25±2	3	3	105±3	30	4	25±2	3
Step	Temperature (°C)		Time (min)															
1	-40±3		30															
2	25±2		3															
3	105±3	30																
4	25±2	3																
		Total: 5 cycles																
		Measured After Exposure in The Room Condition For 1hrs																
1-1-2	High Temperature Resistance		Temperature: 105±3°C Time: 50Hrs Measured After Exposure In The Room Condition For 1Hrs															
1-1-3	Low Temperature Resistance		Temperature: -40±3°C Time: 50Hrs Measured After Exposure In The Room Condition For 1Hrs															
1-1-4	Humidity Load Life	There should be no evidence of short or open circle	Temperature: 40±2°C Relative Humidity: 90~95% Load: Allowed DC Current Time: 96Hrs															

1-2.Mechanical Performance

No	Item	Specification	Test Method
1-2-1	Resistance TO Soldering Heat	Appearance: No Damage	1. The device should be reflow soldered on PCB (peak $260^{\circ}\text{C} \pm 5^{\circ}\text{C}$ for 10 seconds) 2. Solder Composition: Sn/Ag3.0/Cu0.5 3. Test time: 6 minutes
1-2-2	Solder ability	The electrodes shall be at least 95% covered with new solder coating	1. Pre-Heating: 150°C , 1min. 2. Solder Composition: Sn/Ag3.0/Cu0.5 3. Solder Temperature: $245\pm 5^{\circ}\text{C}$. 4. Immersion Time: 4 ± 1 sec.

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Lead-Free(LF)標準溫度分析範圍

Refer to J-STD-020C

管制項目 Item.	升温區 Ramp-up	預熱區 Pre-heating	迴焊區 Reflow	Peak Temp	冷卻區 Cooling
溫度範圍 Temp.scope	R.T ~ 150°C	150°C ~ 200°C	Above 217°C	260±5°C	Peak Temp.~150°C
標準時間 Time spec.	-	60 ~ 180 sec	60 ~ 150 sec	20 ~ 40 sec	-
實際時間 Time result	-	75 ~ 100 sec	90 ~ 120 sec	20 ~ 35 sec	-

NOTE:

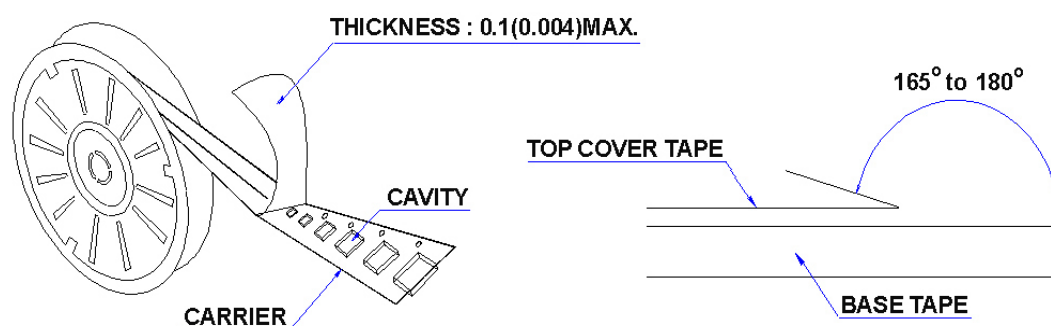
- 1.Re-flow possible times : within 3 times
- 2.Nitrogen adopted is recommended while in re-flow
- 3.Products can only be soldered with reflow

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10 Packaging:

10.1 Packaging -Cover Tape

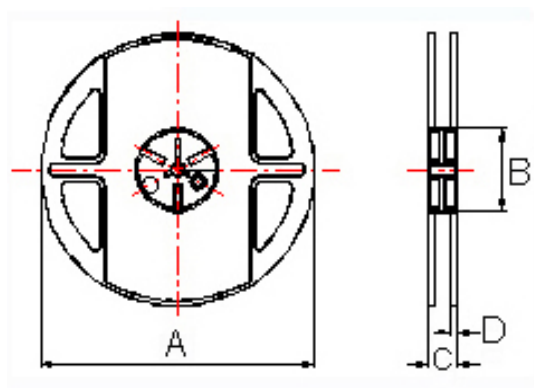
The force for tearing off cover tape is 10 to 100 grams in the arrow direction.



10.2 Packaging Quantity

TYPE	PCS/REEL
60404	4000

10.3 Reel Dimensions



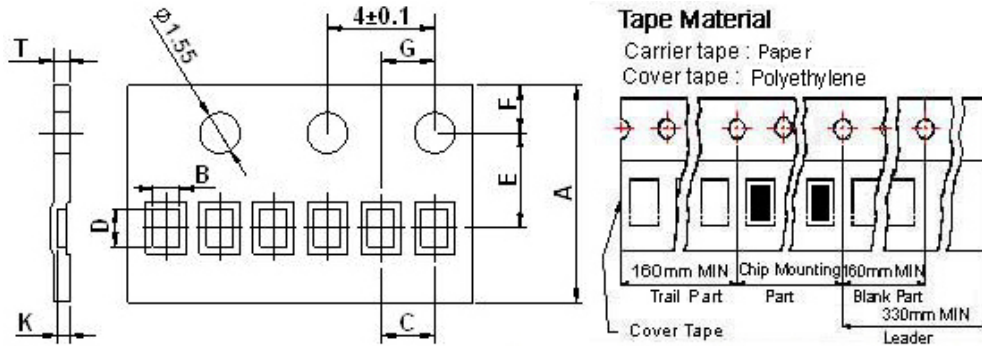
Dimensions in mm

TYPE	A	B	C	D
060404	178±1	60±0.5	12±0.5	1.5±0.5

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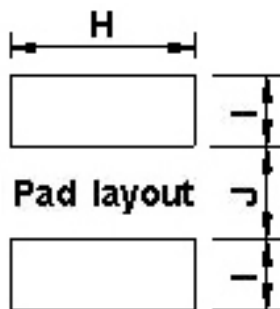
10 Packaging:

10.4 Tape Dimensions in mm



TYPE	A	B	C	D	E	F	G	T	K
060404	8.0	0.44	2	0.64	3.5	1.75	2	0.61	0.45

11 Recommended Land Pattern:



Dimensions in mm

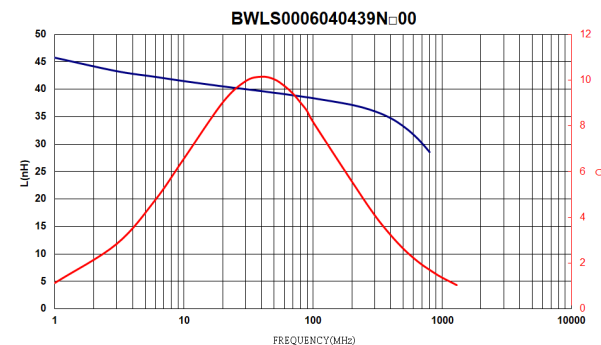
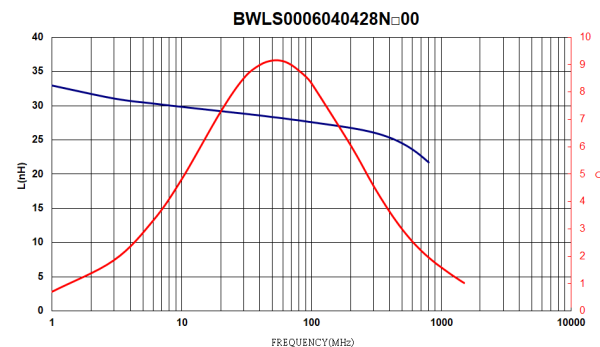
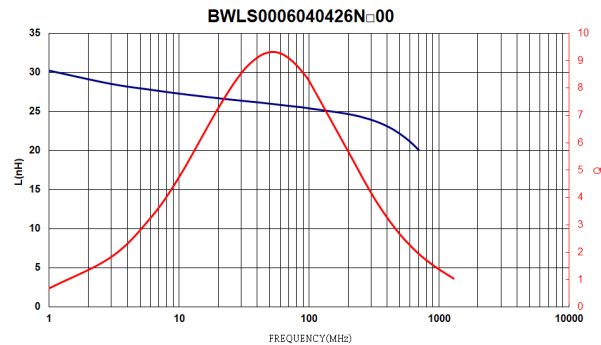
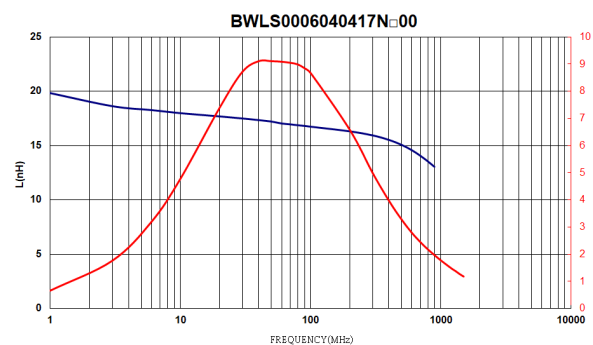
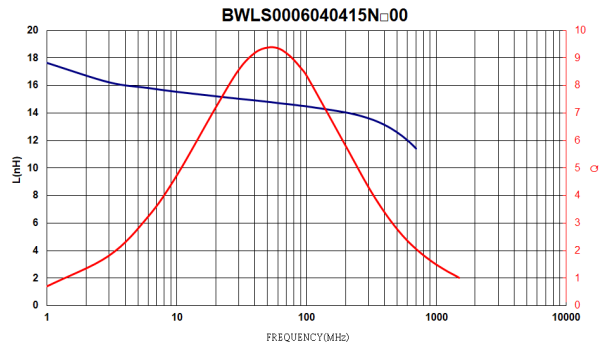
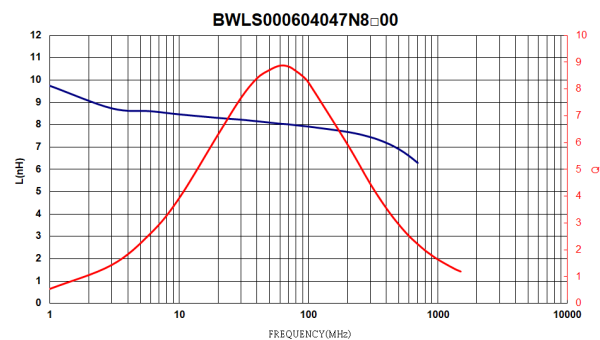
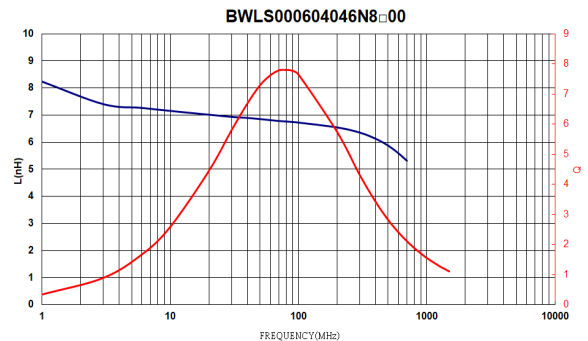
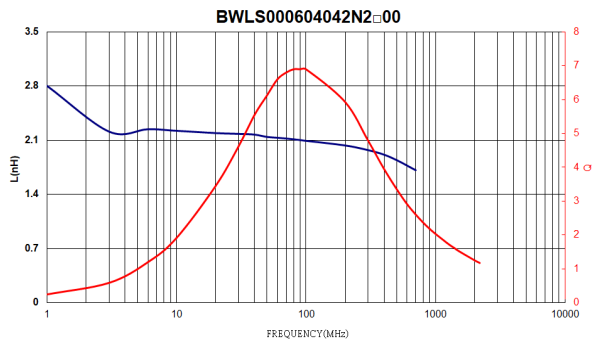
TYPE	H	I	J
060404	0.46	0.18	0.22

12 Note:

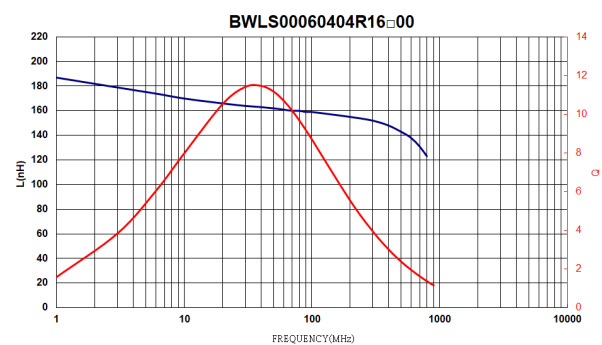
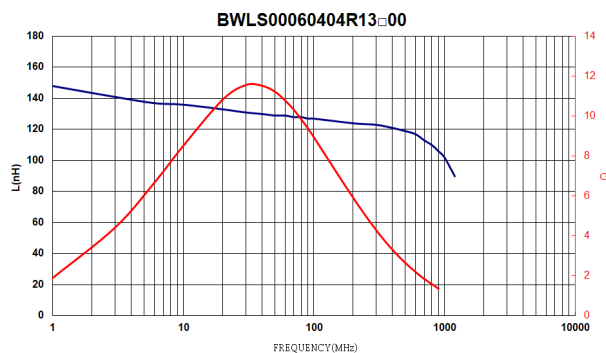
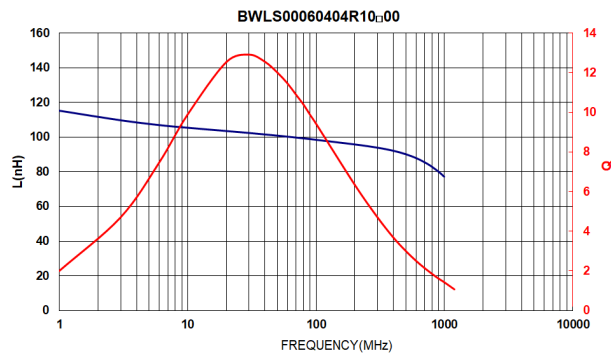
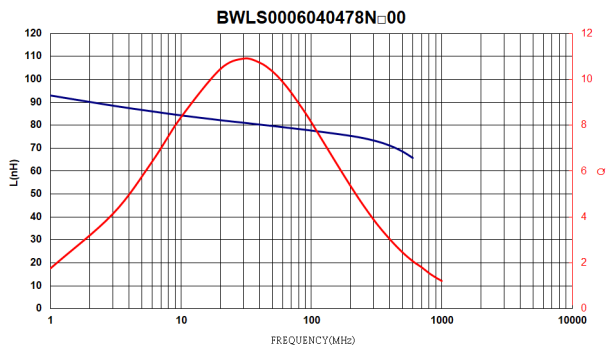
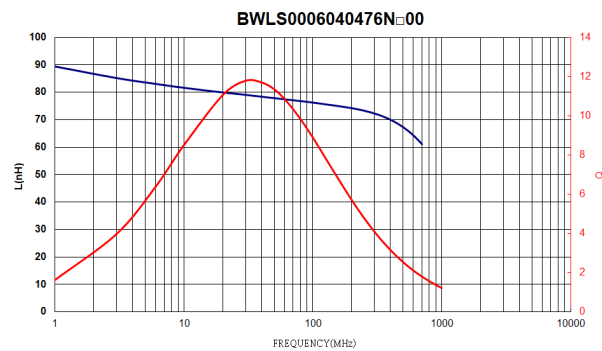
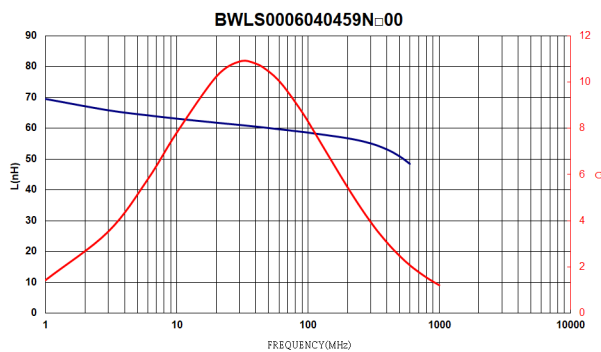
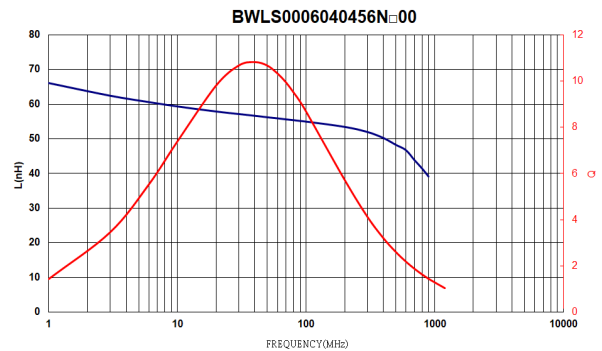
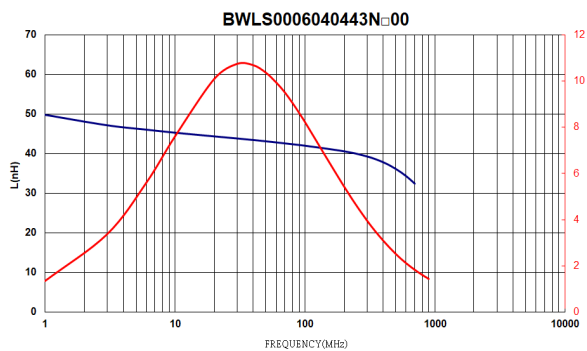
- Please make sure that your product has been evaluated and confirmed against your specifications when our product is mounted to your product.
- Do not knock nor drop.
- All the items and parameters in this product specification have been prescribed on the premise that our product is used for the purpose, under the condition and in the environment agreed upon between you and us. You are requested not to use our product deviating from such agreement.
- The storage period is less than 12 months. Be sure to follow the storage conditions (Temperature: 5 to 40°C, Humidity: 10 to 75% RH or less).
If the storage period elapses, the soldering of the terminal electrodes may deteriorate.
- Do not use or store in locations where there are conditions such as gas corrosion (salt, acid, alkali, etc.).
- The moisture sensitivity level (MSL) of products is classified as level 1

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13 Graph:



BWLS00060404 Series Specification



BWLS00060404 Series Specification

